# Small switching (30V, 2.0A)

# **QS5U12**

# Features

- The QS5U12 combines Nch MOSFET with a Schottky barrier diode in a single TSMT5 package.
- 2) Nch MOSFET have a low on-state resistance with a fast switching.
- 3) Nch MOSFET is reacted a low voltage drive (2.5V).
- 4) The Independently connected Schottky barrier diode have a low forward voltage.

#### Applications

Load switch, DC / DC conversion

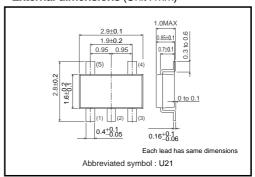
#### ●Structure

Silicon N-channel MOSFET Schottky Barrier DIODE

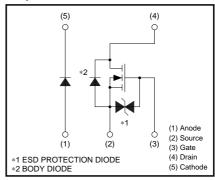
#### Packaging specifications

	Package	Taping		
Type	Code	TR		
	Basic ordering unit (pieces)	3000		
QS5U12		0		

# ●External dimensions (Unit : mm)



# ●Equivalent circuit



# ●Absolute maximum ratings (Ta=25°C)

# <MOSFET>

Parameter		Symbol	Limits	Unit	
Drain-source voltage		V <sub>DSS</sub>	30	V	
Gate-source voltage		V <sub>GSS</sub>	12	V	
Drain current	Continuous	ID	±2.0	Α	
	Pulsed	I <sub>DP</sub>	±8.0	Α	Pw≤10μs, Duty cycle≤1%
Source current	Continuous	Is	0.8 A		
(Body diode)	Pulsed	I <sub>SP</sub>	3.2	Α	Pw≤10μs, Duty cycle≤1%
Channel temperature		Tch	150	°C	
<di></di>					
Repetitive peak reverse voltage		$V_{RM}$	25	V	
Reverse voltage		VR	20	V	
Forward current		lF	1.0	Α	
Forward current surge peak		I <sub>FSM</sub>	3.0	Α	60Hz · 1cyc.
Junction temperature		Tj	150	°C	
<mosfet and="" di=""></mosfet>					
Total power dissipation		P <sub>D</sub>	1.0	W / Total / Mounted on a ceramic board	
Range of Storage temperature		Tstg	-40 to 125	°C	

# ●Electrical characteristics (Ta=25°C)

# <MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	±10	μΑ	V <sub>GS</sub> =±12V / V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	30	_	_	V	I <sub>D</sub> =1mA, / V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	_	1	μΑ	V <sub>DS</sub> =30V / V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	0.5	-	1.5	٧	V <sub>DS</sub> =10V / I <sub>D</sub> =1mA
Static drain-source on-state resistance		-	71	100	mΩ	I <sub>D</sub> =2.0A, V <sub>GS</sub> =4.5V
	R <sub>DS (on)</sub> *	-	76	107	mΩ	I <sub>D</sub> =2.0A, V <sub>GS</sub> =4V
		_	110	154	mΩ	ID=2.0A, VGS=2.5V
Forward transfer admittance	Yfs *	1.5	_	-	S	Vps=10V, Ip=2.0A
Input capacitance	Ciss	-	175	_	pF	V <sub>DS</sub> =10V
Output capacitance	Coss	-	50	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	25	-	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	8	_	ns	ID=1.0A
Rise time	tr *	-	10	_	ns	VDD≒15V
Turn-off delay time	td (off) *	-	21	_	ns	√Vgs=4.5V RL=15Ω
Fall time	t <sub>f</sub> *	_	8	-	ns	Rgs=10Ω
Total gate charge	Qg	_	2.8	3.9	nC	V <sub>DD</sub> ≒15V
Gate-source charge	Qgs	-	0.6	_	nC	V <sub>GS</sub> =4.5V
Gate-drain charge	Q <sub>gd</sub>	_	0.8	_	nC	I <sub>D</sub> =2.0A

<MOSFET>Body diode (source-drain)

Forward voltage	VSD	-	_	1.2	V	I <sub>S</sub> =3.2A / V <sub>GS</sub> =0V
<di></di>						
Forward voltage	VF	_	_	0.45	٧	I <sub>F</sub> =1.0A
Reverse leakage	IR	ı	ı	200	μА	V <sub>R</sub> =20V



#### •Electrical characteristic curves

# <MOSFET>

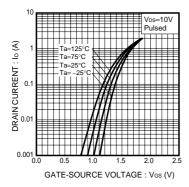


Fig.1 Typical Transfer Characteristics

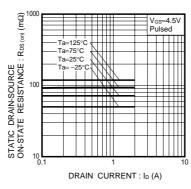


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

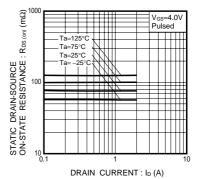


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

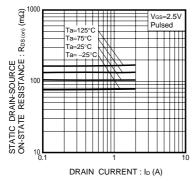


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

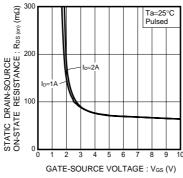


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

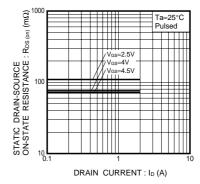


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

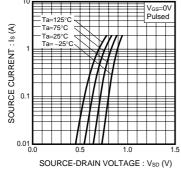


Fig.7 Reverse Drain Current vs. Source-Drain Current

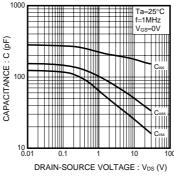


Fig.8 Typical Capacitance vs. Drain-Source Voltage

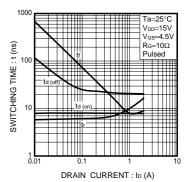


Fig.9 Switching Characteristics

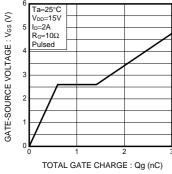


Fig.10 Dynamic Input Characteristics

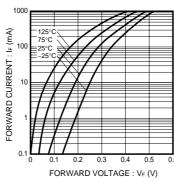


Fig.11 Forward Current vs. Forward Voltage

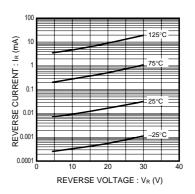


Fig.12 Reverse Current vs. Reverse Voltage

#### ●Measurement circuits

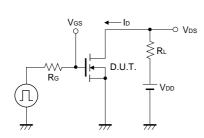


Fig.13 Switching Time Measurement Circuit

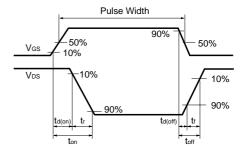


Fig.14 Switching Waveforms

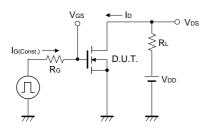


Fig.15 Gate Charge Measurement Circuit

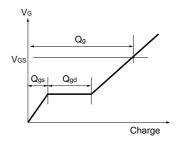


Fig.16 Gate Charge Waveform

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